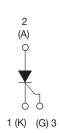


# VS-40TTS12PbF, VS-40TTS12-M3

Vishay Semiconductors

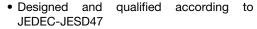
## **High Voltage Phase Control Thyristor, 40 A**

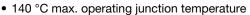




PRODUCT SUMMARY					
Package	TO-220AB				
Diode variation	Single SCR				
I <sub>T(AV)</sub>	25 A				
V <sub>DRM</sub> /V <sub>RRM</sub>	1200 V				
$V_{TM}$	1.6 V				
I <sub>GT</sub>	35 mA				
TJ	- 40 °C to 140 °C				

#### **FEATURES**













## **APPLICATIONS**

 Typical usage is in input rectification crowbar (soft start) and AC switch in motor control, UPS, welding, and battery charge

### **DESCRIPTION**

The VS-40TTS12... high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 140 °C junction temperature.

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
I <sub>T(AV)</sub>	Sinusoidal waveform	25	A			
I <sub>RMS</sub>		40	A			
V <sub>RRM</sub> /V <sub>DRM</sub>		1200	V			
I <sub>TSM</sub>		350	А			
V <sub>T</sub>	T <sub>J</sub> = 25 °C	1.6	V			
dV/dt		500	V/µs			
dl/dt		150	A/μs			
TJ		- 40 to 140	°C			

VOLTAGE RATINGS							
PART NUMBER	V <sub>RRM</sub> , MAXIMUM PEAK REVERSE VOLTAGE V	V <sub>DRM</sub> , MAXIMUM PEAK DIRECT VOLTAGE V	°C T <sub>J</sub>				
VS-40TTS12PbF, VS-40TTS12-M3	1200	1200	- 25 to 140				

# VS-40TTS12PbF, VS-40TTS12-M3

# Vishay Semiconductors

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS	
Maximum average on-state current	I <sub>T(AV)</sub>	T <sub>C</sub> = 93 °C, 180° conduc	tion half sine wave	25		
Maximum RMS on-state current	I <sub>RMS</sub>			40	^	
Maximum peak, one-cycle	ı	10 ms sine pulse, rated \	V <sub>RRM</sub> applied	300	Α	
non-repetitive surge current	I <sub>TSM</sub>	10 ms sine pulse, no vol	tage reapplied	350		
Mar. 1-1	l <sup>2</sup> t	10 ms sine pulse, rated \	V <sub>RRM</sub> applied	450	A <sup>2</sup> s	
Maximum I <sup>2</sup> t for fusing	I <del>-</del> t	10 ms sine pulse, no voltage reapplied		630	A <sup>z</sup> S	
Maximum $I^2\sqrt{t}$ for fusing	I <sup>2</sup> √t	t = 0.1 to 10 ms, no voltage reapplied		6300	A <sup>2</sup> √s	
Maximum on-state voltage	$V_{TM}$	80 A, T <sub>J</sub> = 25 °C		1.6	V	
Low level value of on-state slope resistance	r <sub>t</sub>	T 440.00		11.4	mΩ	
Low level value of threshold voltage	V <sub>T(TO)</sub>	- T <sub>J</sub> = 140 °C		0.96	V	
Maximum reverse and direct leakage	1 /1	T <sub>J</sub> = 25 °C	V Detect V AV	0.5		
current	I <sub>RRM</sub> /I <sub>DRM</sub>	$V_R = Rated V_{RRM}/V_{DRM}$		10	Λ	
Holding current	I <sub>H</sub>	Anode supply = 6 V, resistive load, initial $I_T = 1 A$		100	mA	
Maximum latching current	ΙL	Anode supply = 6 V, resi	200			
Maximum rate of rise of off-state voltage	dV/dt			500	V/µs	
Maximum rate of rise of turned-on current	dl/dt			150	A/µs	

TRIGGERING						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum peak gate power	P <sub>GM</sub>		8.0	W		
Maximum average gate power	P <sub>G(AV)</sub>		2.0	٧٧		
Maximum peak positive gate current	+ I <sub>GM</sub>		1.5	Α		
Maximum peak negative gate voltage	- V <sub>GM</sub>		10	V		
Maximum required DC gate current to trigger	I <sub>GT</sub>	Anode supply = 6 V, resistive load, T <sub>J</sub> = 25 °C	35	mA		
Maximum required DC gate voltage to trigger	V <sub>GT</sub>	Anode supply = 6 V, resistive load, T <sub>J</sub> = 25 °C	1.3	٧		
Maximum DC gate voltage not to trigger	$V_{GD}$	T = 140 °C V = Poted value	0.2			
Maximum DC gate current not to trigger	I <sub>GD</sub>	T <sub>J</sub> = 140 °C, V <sub>DRM</sub> = Rated value	1.5	mA		

SWITCHING						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Typical turn-on time	t <sub>gt</sub>	T <sub>J</sub> = 25 °C	0.9			
Typical reverse recovery time	t <sub>rr</sub>	T <sub>.1</sub> = 140 °C	4	μs		
Typical turn-off time	t <sub>q</sub>	1J = 140 C	110			

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range		T <sub>J</sub> , T <sub>Stg</sub>		- 40 to 140	°C	
Maximum thermal resistance, junction to case		$R_{\text{thJC}}$	DC operation	0.8		
Maximum thermal resistance, junction to ambient		$R_{thJA}$		60	°C/W	
Typical thermal resistance, case to heatsink		R <sub>thCS</sub>	Mounting surface, smooth and greased	0.5		
Approximate weight				2	g	
Approximate weight				0.07	OZ.	
Mounting torque	minimum			6 (5)	kgf · cm	
Modifiling torque	maximum			12 (10)	(lbf · in)	
Marking device	Marking device		Case style TO-220AB	40T	ΓS12	

#### www.vishay.com

## Vishay Semiconductors

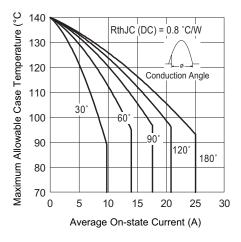


Fig. 1 - Current Rating Characteristics

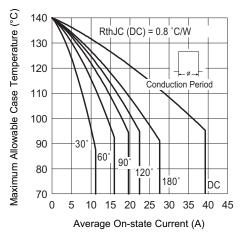


Fig. 2 - Current Rating Characteristics

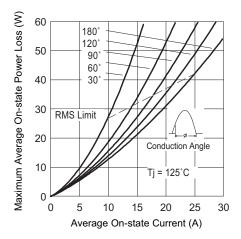


Fig. 3 - On-State Power Loss Characteristics

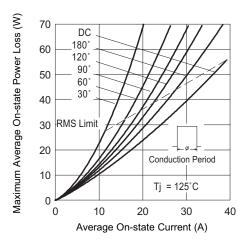


Fig. 4 - On-State Power Loss Characteristics

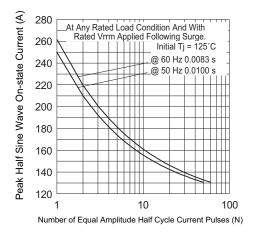


Fig. 5 - Maximum Non-Repetitive Surge Current

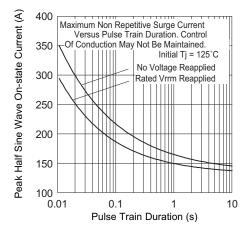


Fig. 6 - Maximum Non-Repetitive Surge Current

## Vishay Semiconductors

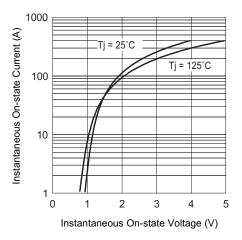


Fig. 7 - On-State Voltage Drop Characteristics

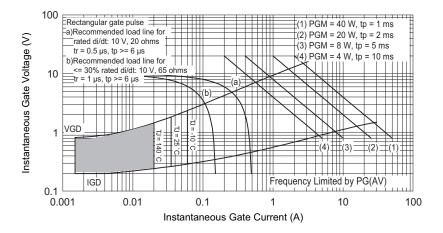


Fig. 8 - Gate Characteristics

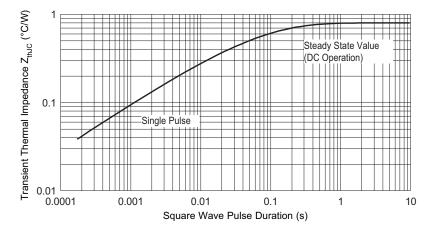


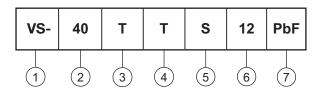
Fig. 9 - Thermal Impedance Z<sub>thJC</sub> Characteristics

# **VS-40TTS12PbF, VS-40TTS12-M3**

Vishay Semiconductors

## **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - Current rating, RMS value

3 - Circuit configuration:

T = Single thyristor

4 - Package:

T = TO-220

5 - Type of silicon:

S = Standard recovery rectifier

6 - Voltage rating (12 = 1200 V)

7 - Environmental digit:

PbF = Lead (Pb)-free and RoHS compliant

-M3 = Halogen-free, RoHS compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N QUANTITY PER T/R MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION						
VS-40TTS12PbF	50	1000	Antistatic plastic tubes			
VS-40TTS12-M3	50	1000	Antistatic plastic tubes			

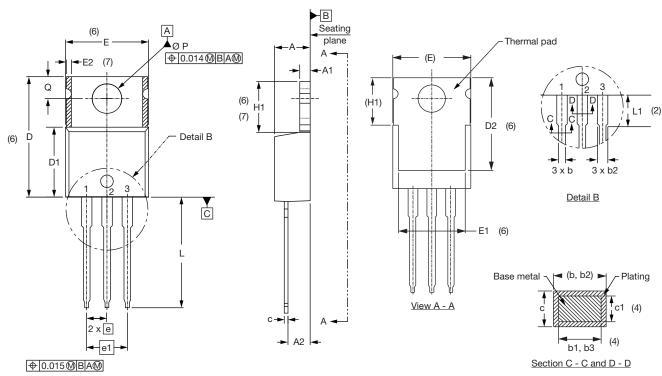
LINKS TO RELATED DOCUMENTS					
Dimensions www.vishay.com/doc?95222					
Part marking information	TO-220AB PbF	www.vishay.com/doc?95225			
Part marking information	TO-220AB -M3	www.vishay.com/doc?95028			



## Vishay Semiconductors

## **TO-220AB**

#### **DIMENSIONS** in millimeters and inches



## Lead assignments

#### **Diodes**

- 1. Anode/open
- 2. Cathode
- 3. Anode

#### Conforms to JEDEC outline TO-220AB

MILLIMETERS		INC	NOTES	
MIN.	MAX.	MIN.	MAX.	NOTES
4.25	4.65	0.167	0.183	
1.14	1.40	0.045	0.055	
2.56	2.92	0.101	0.115	
0.69	1.01	0.027	0.040	
0.38	0.97	0.015	0.038	4
1.20	1.73	0.047	0.068	
1.14	1.73	0.045	0.068	4
0.36	0.61	0.014	0.024	
0.36	0.56	0.014	0.022	4
14.85	15.25	0.585	0.600	3
8.38	9.02	0.330	0.355	
11.68	12.88	0.460	0.507	6
	MIN. 4.25 1.14 2.56 0.69 0.38 1.20 1.14 0.36 0.36 14.85 8.38	MIN.         MAX.           4.25         4.65           1.14         1.40           2.56         2.92           0.69         1.01           0.38         0.97           1.20         1.73           1.14         1.73           0.36         0.61           0.36         0.56           14.85         15.25           8.38         9.02	MIN.         MAX.         MIN.           4.25         4.65         0.167           1.14         1.40         0.045           2.56         2.92         0.101           0.69         1.01         0.027           0.38         0.97         0.015           1.20         1.73         0.047           1.14         1.73         0.045           0.36         0.61         0.014           0.36         0.56         0.014           14.85         15.25         0.585           8.38         9.02         0.330	MIN.         MAX.         MIN.         MAX.           4.25         4.65         0.167         0.183           1.14         1.40         0.045         0.055           2.56         2.92         0.101         0.115           0.69         1.01         0.027         0.040           0.38         0.97         0.015         0.038           1.20         1.73         0.047         0.068           1.14         1.73         0.045         0.068           0.36         0.61         0.014         0.024           0.36         0.56         0.014         0.022           14.85         15.25         0.585         0.600           8.38         9.02         0.330         0.355

SYMBOL	MILLIN	MILLIMETERS INCHES		NOTES	
STIVIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
E	10.11	10.51	0.398	0.414	3, 6
E1	6.86	8.89	0.270	0.350	6
E2	-	0.76	-	0.030	7
е	2.41	2.67	0.095	0.105	
e1	4.88	5.28	0.192	0.208	
H1	6.09	6.48	0.240	0.255	6, 7
L	13.52	14.02	0.532	0.552	
L1	3.32	3.82	0.131	0.150	2
ØΡ	3.54	3.73	0.139	0.147	
Q	2.60	3.00	0.102	0.118	
θ	90° t	o 93°	90° t	o 93°	
	•				

#### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline

Document Number: 95222 Revision: 08-Mar-11

Lead tip



## **Legal Disclaimer Notice**

Vishay

## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

## **Material Category Policy**

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.